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A Versatile and Efficient 0.1-to-11 Gb/s CML Transmitter in 40-nm CMOS

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Abstract— **We present a wireline transmitter (TX) for reconfigurable chip-to-chip links. The proposed design features a frequency-adaptive clock chain, a fast 16:1 clocked-CMOS multiplexer (C^2MOS MUX) tree, and a full-rate synchronous current-mode logic (CML) clock driver. A prototype realized in 40-nm CMOS accomplishes a wide 0.1-to-11 Gb/s operation range ($f_{max}/f_{min} = 110\times$). At 11 Gb/s, the prototype achieves 3.98 pJ/bit for a bit error rate (BER) $< 10^{-12}$ with a 60.9-ps eye width.**

I. Introduction

An impressive surge of advanced radio frequency (RF) transmitters (TXs) has enabled reconfigurable (multi-channel) communication solutions with effective data rates from 100 Mb/s up to 10 Gb/s, catering applications with various bandwidth such as LTE-cat M, 802.11 ah/ax, and sub-6 GHz 5G.

However, the chip-to-chip *wireline* links that provide the baseband data must be able to operate with equal flexibility. Today's wireline standards, such as JESD204B for high-end data converters, do not support $f_{max}/f_{min} \geq 100\times$ yet. To tackle this problem, we present a 40-nm CMOS wireline TX that supports a variable data rate of 0.1 to 11 Gb/s, targeting a bit error rate (BER) $\leq 10^{-12}$ and energy efficiency < 5 pJ/bit.

II. Wireline Transmitter Implementation

Fig. 1 shows the proposed wireline TX architecture. A wideband on-chip transformer accepts a single-ended full-rate clock for a 0.1-to-11 GHz frequency-adaptive clock chain to generate five complementary clocks. A pseudo-random bit stream (PRBS) feeds the 16:1, full-rate binary tree multiplexer (MUX), for up to $2\times$ 8-b complex data. A clocked-CMOS (C^2MOS) design enables a fast but low-power MUX. Two four-stage, 50-Ω current-mode logic (CML) output driver (OD) chains synchronously transmit the low-swing, high-speed data, and its full-rate forwarded clock, respectively, to facilitate clock recovery-less links. The nominal 300-mV_{pp} swings are adjustable through a current reference.

A. Frequency-Adaptive Clock Chain

The generation of well-aligned, divided clocks across wide frequencies for a tree MUX is challenging due to substantial variation of relative propagation delays across divider chains (t_{BUF}) and retimers (t_{CQ}). Fig. 2(a) illustrates the desired scenario that should be satisfied up to 11 GHz. To address this, we propose a two-step approach for this clock chain design: coarse-fine self-retiming, combined with a simple binary delay.

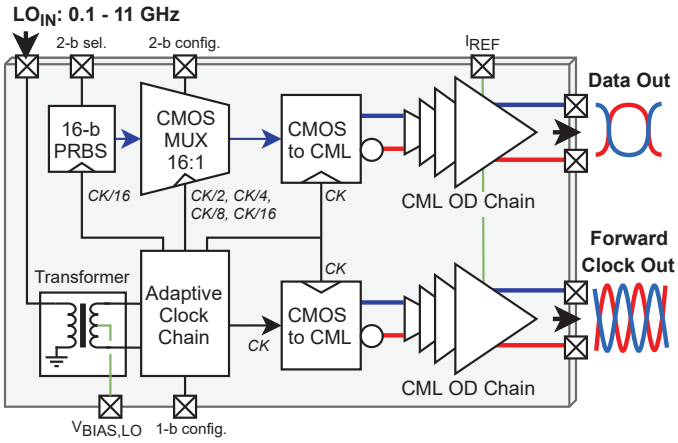


Fig. 1. Proposed wireline TX architecture. The high-speed outputs are synchronized and ESD-protected (300 fF per pad).

Fig. 2(b) depicts the frequency-adaptive clock chain architecture. Dividers must employ buffers that incur unwanted delays, resulting in variable accumulated skew. The coarse self-retimer minimizes these delays by taking each internally mini-buffered "parent"-clock ck/i, to retime its divided "child"-clock ck/j ($j = 2i$). Consequently, short delay lines easily compensate for the remaining fixed parent-to-child skews, such that "fine" flip-flops (FFs) safely perform the final retime.

By merit of this approach, frequency-dependent timing constraints are exclusively isolated at the clock of the fine FFs (CK_{IN}). Effectively, a single circuit can now close clock chain timing across variable data rates. To this end, a controlled XOR-gate in the CK_{IN} path is inserted to enable a 0/180-degree phase shift, i.e., a frequency-dependent delay.

B. Inherently-Pipelined C^2MOS MUX

Without having to resort to a power-hungry CML MUX, we adopt a custom-digital C^2MOS MUX structure, originally introduced as a "clocked inverter multiplexer" by [1]. The C^2MOS MUX, shown in Fig. 3, inherently exhibits the FF-function (pipelining) that decouples MUX slice depth from its speed. In our proposed design, the clocked (cascode) gates are kept at a minimum size to prevent significant clock feedthrough. The data-driven gates are sized to minimize the critical clock-to-Q delays, such that only intrinsic rise/fall times limit the MUX clock frequency (f_{MUX}), enabling high speeds.

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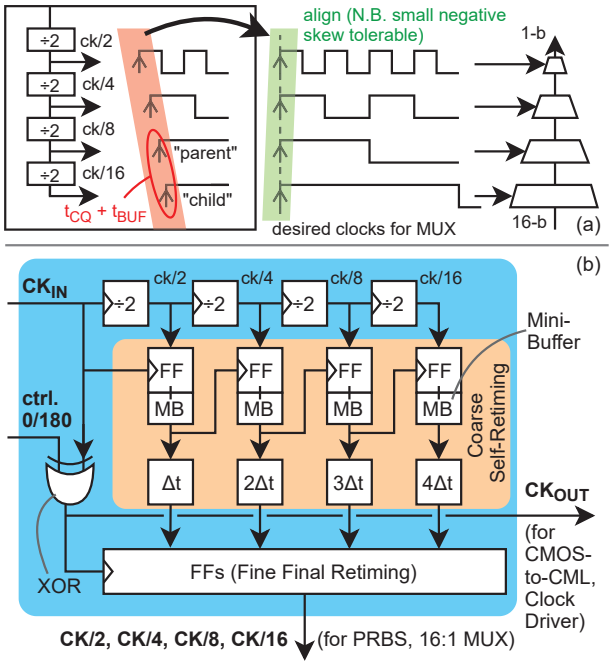


Fig. 2. Proposed frequency adaptive clock chain. (a) Tree MUX clock alignment. (b) Implementation details (all clocks are complementary).

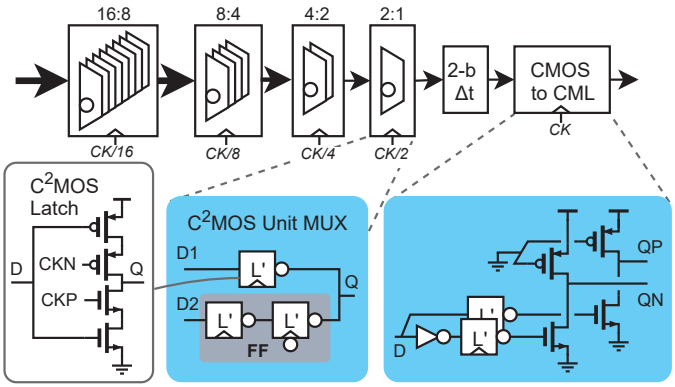


Fig. 3. Implemented C^{2}MOS MUX tree based on [1] and the proposed CMOS-to-CML converter.

A proposed "CMOS-to-CML" circuit succeeds the MUX and converts the single-phase MUX data to its complementary, high-common mode counterpart, re-using the C^{2}MOS latch. This clocked arrangement achieves near-perfect skew-cancellation (critical for CML circuitry) and enables coherency for the two driver chains. A 120-ps full-scale, 2-bit delay line ensures sufficient converter timing margin across frequency. The 16:1, C^{2}MOS MUX achieves >12.5 Gb/s for <300 μW at 1.1 V in post-layout simulations.

III. Measurement Results

The prototype wireline TX is fabricated in 40-nm CMOS with 0.1-mm^2 core area. The TX achieves 0.1-to-11 Gb/s operation, speed-limited by the input transformer bandwidth (lower than the f_{MUX}-limit expected at ≈ 12.5 Gb/s). Fig. 4 shows the measured eye diagram at 11 Gb/s with a 325-mV$_{pp}$ swing, resulting in a 60.9-ps wide eye opening for a

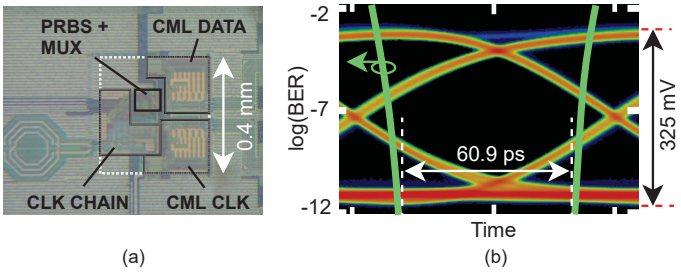


Fig. 4. Wireline TX prototype. (a) Die photo. (b) Measured eye diagram and bathtub curve (green overlay) at 11 Gb/s.

TABLE I
Performance Comparison

	This Work	[2]$^\Delta$	[3]$^\Delta$	[4]
Process	**40 nm**	28 nm	40 nm	65 nm
Driver Circuit	**CML**	LVDS / *SST*	SST	SST
Data Rate (Gb/s)	**≤11**	12.5	≤12.5	≤8.5
Swing* (mV$_{pp}$)	**325**	135 / *703*	648	1000
Total Jitter*† (ps)	**24.9**	*27* / *28*	-	17.5
Efficiency* (pJ/bit)	**3.98 (2.66$^\#$)**	1.1 / *1.7*	2.88	11.3
f_{max}/f_{min} Range	**110×**	-	12.5×	1.7×

*data rate = f_{max}; †log(BER) = -12; $^\#$w/o clock driver; $^\Delta$targets JESD204B

BER $\leq 10^{-12}$. The ESD-protected channel (>300 fF total per pad) consists of 1.5-mm bondwires and 2-cm FR4 traces. At 11 Gb/s, the efficiency is 3.98 pJ/bit, and improves to an optimal 2.68 pJ/bit at 8 Gb/s. Analog power dominates at <8 Gb/s, which can be compensated for by reducing the swing. Table I compares this performance to the prior art, including some voltage-mode driver (SST) TXs. Our prototype CML TX demonstrates at least 8× better f_{max}/f_{min}, for no more than 4× additional relative power *including* the coherent clock driver.

IV. Conclusion

This paper presented a wireline TX in 40-nm CMOS to accommodate for the future demand of highly variable data rates as high as 10 Gb/s. The proposed frequency-adaptive clock chain and 16:1 high-speed, inherently pipelined C^{2}MOS MUX achieve a 0.1-to-11 Gb/s operational data rate, better than the 42× f_{max}/f_{min}-range of the full JESD204B standard. Despite the built-in versatility, the prototype TX achieves an efficiency of 3.98 pJ/bit for a BER$<10^{-12}$ (60.9-ps eye width) at 11 Gb/s, including two coherent CML drivers for data and a forwarded clock.

Acknowledgment

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